

SCTWA50N120

Silicon carbide Power MOSFET 1200 V, 65 A, 59 mΩ (typ., TJ=150 °C) in an HiP247™ long leads package

Datasheet - production data

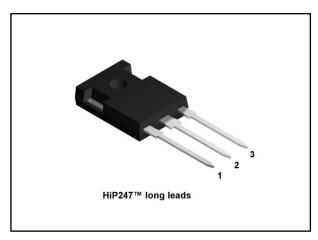
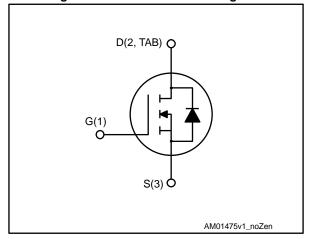


Figure 1: Internal schematic diagram



Features

- Very tight variation of on-resistance vs. temperature
- Very high operating junction temperature capability (T_J = 200 °C)
- Very fast and robust intrinsic body diode
- Low capacitance

Applications

- Solar inverters, UPS
- Motor drives
- High voltage DC-DC converters
- Switch mode power supplies

Description

This silicon carbide Power MOSFET is produced exploiting the advanced, innovative properties of wide bandgap materials. This results in unsurpassed on-resistance per unit area and very good switching performance almost independent of temperature. The outstanding thermal properties of the SiC material allows designers to use an industry-standard outline with significantly improved thermal capability. These features render the device perfectly suitable for high-efficiency and high power density applications.

Table 1: Device summary

Order code	Marking	Package	Packaging
SCTWA50N120	SCT50N120	HiP247™ long leads	Tube

Contents SCTWA50N120

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SCTWA50N120 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	1200	V	
V_{GS}	Gate-source voltage	-10 to 25	V	
I _D	Drain current (continuous) at T _C = 25 °C	65	Α	
I _D	Drain current (continuous) at T _C = 100 °C	50	Α	
I _{DM} ⁽¹⁾	Drain current (pulsed)	130	Α	
Ртот	Total dissipation at T _C = 25 °C	318	W	
T _{stg}	Storage temperature range	FF to 200	°C	
Tj	Operating junction temperature range	-55 to 200 °C		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.55	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	40	°C/W

⁽¹⁾Pulse width limited by safe operating area.

Electrical characteristics SCTWA50N120

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified).

Table 4: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	Zero gate voltage	V _{DS} = 1200 V, V _{GS} = 0 V		1	100	μΑ
I _{DSS}	drain current	V _{DS} = 1200 V, V _{GS} = 0 V, T _J = 200 °C		10		μΑ
Igss	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = -10 to 22 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$	1.8	3.0		V
		$V_{GS} = 20 \text{ V}, I_{D} = 40 \text{ A}$		52	69	mΩ
R _{DS(on)} Static drain-source on-resistance	$V_{GS} = 20 \text{ V}, I_D = 40 \text{ A},$ $T_J = 150 \text{ °C}$		59		mΩ	
	V _{GS} = 20 V, I _D = 40 A, T _J = 200 °C		70		mΩ	

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1900	-	pF
Coss	Output capacitance	V _{DS} = 400 V, f = 1 MHz, V _{GS} = 0 V	-	170	-	pF
C _{rss}	Reverse transfer capacitance		-	30	-	pF
Qg	Total gate charge	$V_{DD} = 800 \text{ V}, I_D = 40 \text{ A},$ $V_{GS} = 0 \text{ to } 20 \text{ V}$	-	122	-	nC
Qgs	Gate-source charge		-	19	-	nC
Q _{gd}	Gate-drain charge	VGS - U 10 20 V	-	35	-	nC
Rg	Gate input resistance	f=1 MHz open drain	-	1.9	-	Ω

Table 6: Switching energy (inductive load)

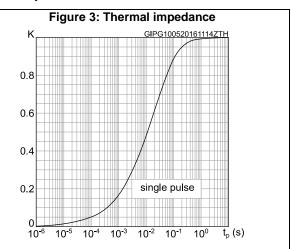
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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon	Turn-on switching energy	$V_{DD} = 800 \text{ V}, I_{D} = 40 \text{ A}$	-	530	1	μJ
E _{off}	Turn-off switching energy	R_G = 2.2 Ω , V_{GS} = -5 to 20 V	-	310	-	μJ
Eon	Turn-on switching energy	$V_{DD} = 800 \text{ V}, I_{D} = 40 \text{ A}$	-	670	1	μJ
E _{off}	Turn-off switching energy	R_G = 2.2 Ω , V_{GS} = -5 to 20 V T_J = 150 °C	-	334	-	μJ

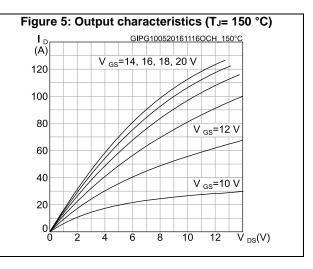
Table 7: Reverse SiC diode characteristics

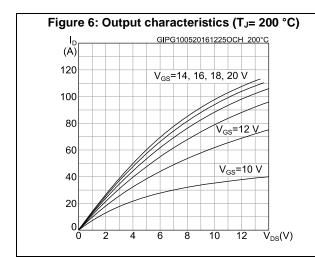
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V _{SD}	Diode forward voltage	I _F = 20 A, V _{GS} = 0 V	-	3.5	-	V
t _{rr}	Reverse recovery time	1 40 A 11/14 0000/	-	55		ns
Qrr	Reverse recovery charge I _F = 40 A, di/dt = 2000/ns V _{DD} = 800 V		-	230	-	nC
I _{RRM}	Reverse recovery current	עט ע – טטט ע	-	14	-	Α

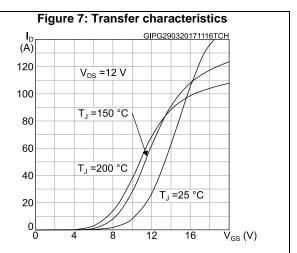
2.1 Electrical characteristics (curves)

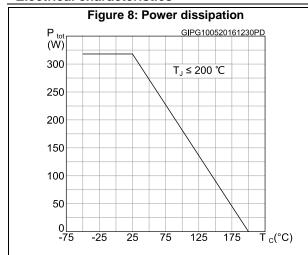
Figure 2: Safe operating area GIPG100520161114SOA Operation in this area is limited by R_{DS(on)} 10² 10¹ t_p=100 μs t₀=1 ms T_j≤ 200 °C 10⁰ T_c= 25°C t₀=10 ms single pulse V_{DS} (V) 10⁰ 10¹ 10^{2} 10³

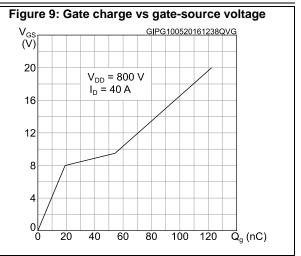


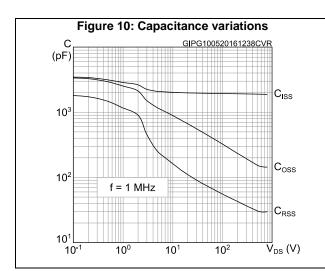


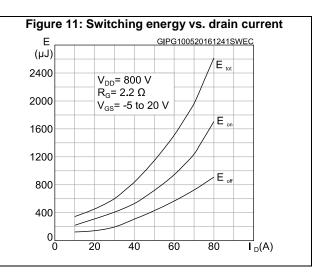


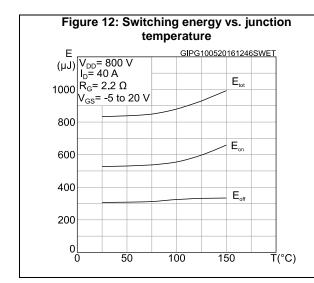


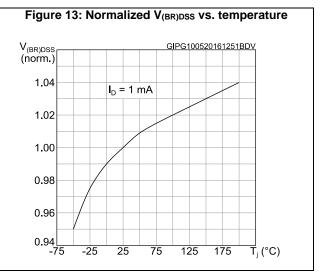












SCTWA50N120 Electrical characteristics

Figure 14: Normalized gate threshold voltage vs. temperature V _{GS(th)} (norm.) GIPG100520161252VTH $I_D = 1 \text{ mA}$ 1.4 1.2 1.0 0.8 0.6L -75 25 -25 75 125 175 T_i(°C)

Figure 16: Reverse conduction characteristics (T_J = -50 °C)

(T_J = -50 °C)

(A)

(A)

(B)

(GIPG100520161253BCD

(V_{GS}= -2 V

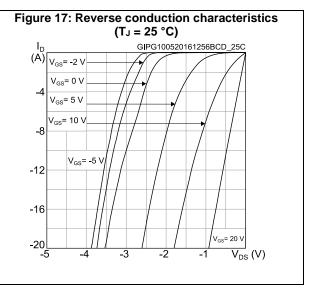
(V_{GS}= 0 V

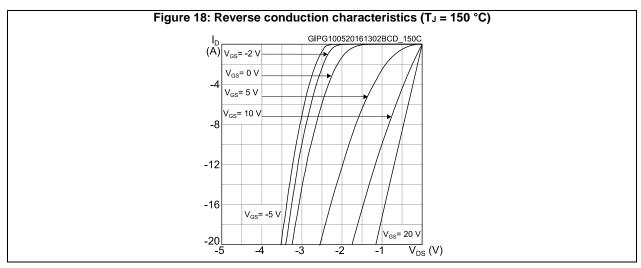
(V_{GS}= 5 V

(V_{GS}= 10 V

(V_{GS}= -5 V

(V_{GS}= 20 V





3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

3.1 HiP247™ long leads package information

Figure 19: HiP247™ long leads package outline

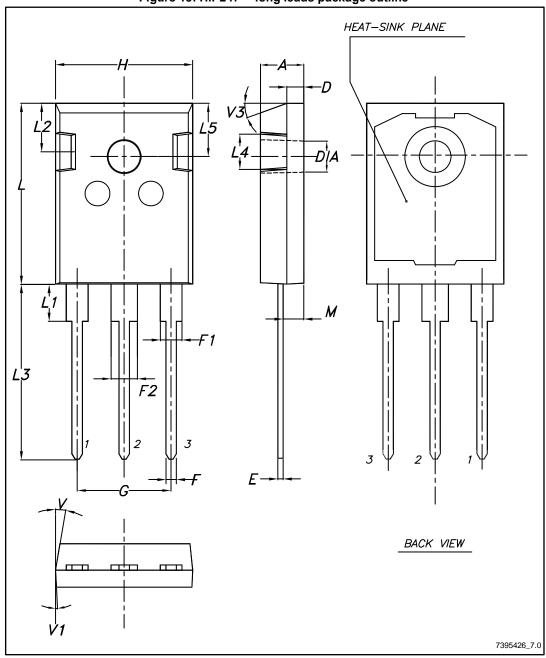


Table 8: HiP247™ long leads package mechanical data

land of the Z47 long leads puckage mechanical data					
Dim.		mm			
Dilli.	Min.	Тур.	Max.		
А	4.90		5.15		
D	1.85		2.10		
Е	0.55		0.67		
F	1.07		1.32		
F1	1.90		2.38		
F2	2.87		3.38		
G	10.90 BSC				
Н	15.77		16.02		
L	20.82		21.07		
L1	4.16		4.47		
L2	5.49		5.74		
L3	20.05		20.30		
L4	3.68		3.93		
L5	6.04		6.29		
M	2.25		2.55		
V		10°			
V1		3°			
V3		20°			
DIA	3.55		3.66		

Revision history SCTWA50N120

4 Revision history

Table 9: Document revision history

Date	Revision	Changes
07-Jun-2016	1	First release
14-Sep-2016	2	Document status changed from preliminary to production data.
03-Apr-2017	3	Modified Table 7: "Reverse SiC diode characteristics" Modified Figure 7: "Transfer characteristics", Figure 15: "Normalized on-resistance vs. temperature", Figure 16: "Reverse conduction characteristics ($T_J = -50$ °C)", Figure 17: "Reverse conduction characteristics ($T_J = 25$ °C)" and Figure 18: "Reverse conduction characteristics ($T_J = 150$ °C)" Minor text changes.

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